FEATURES

- 650 V enhancement mode power transistor
- Bottom-cooled, 8x8 mm PDFN package
- $R_{DS(on)(Typ)}$ = 78 mΩ
- $I_{DSmax,DC}$ = 18 A / $I_{DSmax,Pulse}$ = 35 A
- Simple gate drive requirements (0 V to 6 V)
- Transient tolerant gate drive (-20 V / +10 V)
- High switching frequency (> 1 MHz)
- Fast and controllable fall and rise times
- Reverse conduction capability
- Zero reverse recovery loss
- Source Sense (SS) pin for optimized gate drive
- ROHS Compliant
- Halogen-free

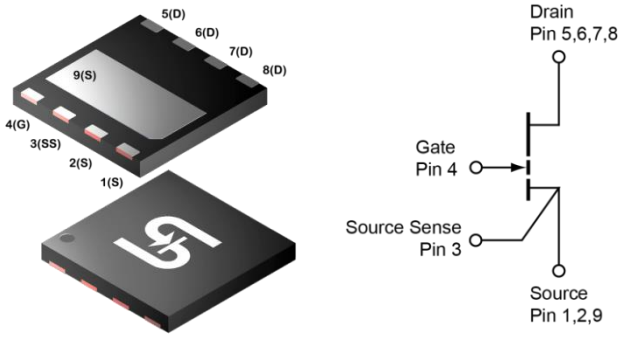
APPLICATIONS

- Consumer and Industrial Power Supplies
- Power Adapters
- LED Lighting Drivers
- Fast Battery Charging
- Power Factor Correction
- Appliance and Industrial Motor Drives
- Wireless Power Transfer

KEY PERFORMANCE PARAMETERS			
PARAMETER		**VALUE**	**UNIT**
V_{DS}		650	V
$R_{DS(on)}$ (max)	V_{GS} = 6V	110	mΩ
Q_g		4	nC

Pb-Free RoHS COMPLIANT HALOGEN FREE

PDFN88



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V_{DS}	650	V
Drain-to-Source Voltage – transient (Note 1)		$V_{DS(transient)}$	850	V
Gate-Source Voltage		V_{GS}	-10 to +7	V
Gate-to-Source Voltage - transient (Note 1)		$V_{GS(transient)}$	-20 to +10	V
Continuous Drain Current	T_C = 25°C	I_{DS}	18	A
	T_C = 100°C		12	
Pulse Drain Current (Pulse width 10 μs, V_{GS} = 6 V) (Note 2)		$I_{DS\ Pulse}$	35	
Operating Junction Temperature		T_J	-55 to +150	°C
Storage Temperature Range		T_S	-55 to +150	°C

Notes:

1. For ≤ 100 μs
2. Defined by product design and characterization. Value is not tested to full current in production.

THERMAL PERFORMANCE			
PARAMETER	**SYMBOL**	**LIMIT**	**UNIT**
Junction to Case Thermal Resistance	$R_{\Theta JC}$	1.24	°C/W
Junction to Ambient Thermal Resistance(Note 3)	$R_{\Theta JA}$	36	°C/W

Notes:

3. Device mounted on 1.6 mm PCB thickness FR4, 4-layer PCB with 2 oz. copper on each layer. The recommendation for thermal vias under the thermal pad is 0.3 mm diameter (12 mil) with 0.635 mm pitch (25 mil). The copper layers under the thermal pad and drain pad are 25 x 25 mm2 each. The PCB is mounted in horizontal position without air stream cooling

Electrical Characteristics (Typical values at T_J = 25 °C, V_{GS} = 6 V unless otherwise noted)						
PARAMETER	**CONDITIONS**	**SYMBOL**	**MIN**	**TYP**	**MAX**	**UNIT**
Drain-to-Source Blocking Voltage	V_{GS} = 0 V, I_{DSS} ≤ 35 µA	$V_{(BL)DSS}$	650	--	--	V
Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 4.8mA	$V_{GS(TH)}$	1.1	1.7	2.6	V
Gate-to-Source Current	V_{GS} = 6 V, V_{DS} = 0 V	I_{GS}	--	110	--	µA
Drain-Source Leakage Current	V_{DS} = 650 V, V_{GS} = 0 V T_J = 25 °C	I_{DSS}	--	1.2	35	µA
	V_{DS} = 650 V, V_{GS} = 0 V T_J = 150 °C		--	42	--	
Drain-Source On-State Resistance	V_{GS} = 6 V, T_J = 25 °C I_{DS} = 5.5 A	$R_{DS(on)}$	--	78	110	mΩ
	V_{GS} = 6 V, T_J = 150 °C I_{DS} = 5.5 A		--	197	--	
Total Gate Charge	V_{GS} = 0 to 6 V V_{DS} = 400 V	Q_g	--	4	--	nC
Gate-Source Charge		Q_{gs}	--	1.2	--	
Gate-Drain Charge		Q_{gd}	--	1.2	--	
Output Charge	V_{GS} = 0 V, V_{DS} = 400 V	Q_{OSS}	--	37	--	
Gate Plateau Voltage	V_{DS} = 400 V,I_{DS} = 18 A	Vplat	--	3.5	--	V
Internal Gate Resistance	f = 5 MHz, open drain	R_G		1.3		Ω
Input Capacitance	V_{DS} = 400 V V_{GS} = 0 V f = 100 kHz	C_{iss}	--	132	--	pF
Output Capacitance		C_{oss}	--	34	--	
Reverse Transfer Capacitance		C_{rss}	--	0.4	--	
Effective Output Capacitance Energy Related (Note 4)	V_{GS} = 0 V V_{DS} = 0 to 400 V	$C_{O(ER)}$	--	58	--	
Effective Output Capacitance Time Related (Note 5)		$C_{O(TR)}$	--	90	--	
Reverse Recovery Charge		Qrr	--	0	--	nC

Notes:

4. $C_{O(ER)}$ is the fixed capacitance that would give the same stored energy as C_{OSS} while V_{DS} is rising from 0 V to the stated V_{DS}.
5. $C_{O(TR)}$ is the fixed capacitance that would give the same charging time as C_{OSS} while V_{DS} is rising from 0 V to the stated V_{DS}.

Electrical Characteristics cont'd (Typical values at T_J = 25 °C, V_{GS} = 6 V unless otherwise noted)						
PARAMETER	**CONDITIONS**	**SYMBOL**	**MIN**	**TYP**	**MAX**	**UNIT**
Turn-On Delay	V_{DD} = 400 V, V_{GS} = +6/-3 V, I_{DS} = 10 A, $R_{G(on)}$ = 10 Ω, $R_{G(off)}$ = 2 Ω, L = 110 μH, L_P = 12 nH (Notes 6 , 7, 8)	$t_{D(on)}$	--	1.5	--	nS
Rise Time		t_R	--	5.0	--	
Turn-Off Delay		$t_{D(off)}$	--	2.9	--	
Turn-Off Fall Time		t_F	--	4.8	--	
Switching Energy during turn-on		E_{on}	--	16.4	--	μJ
Switching Energy during turn-off		E_{off}	--	7.5	--	
Output Capacitance Stored Energy	V_{DS} = 400 V V_{GS} = 0 V, f = 100 kHz	E_{OSS}	--	4.6	--	

Notes:

6. See Figure 16 for switching test circuit diagram.
7. See Figure 17 for switching time definition waveforms.
8. L_P = parasitic inductance

ORDERING INFORMATION

ORDERING CODE	PACKAGE	PACKING
TSG65N110CE RVG	PDFN88	3,000pcs / 13" Reel

Electrical Performance Graphs

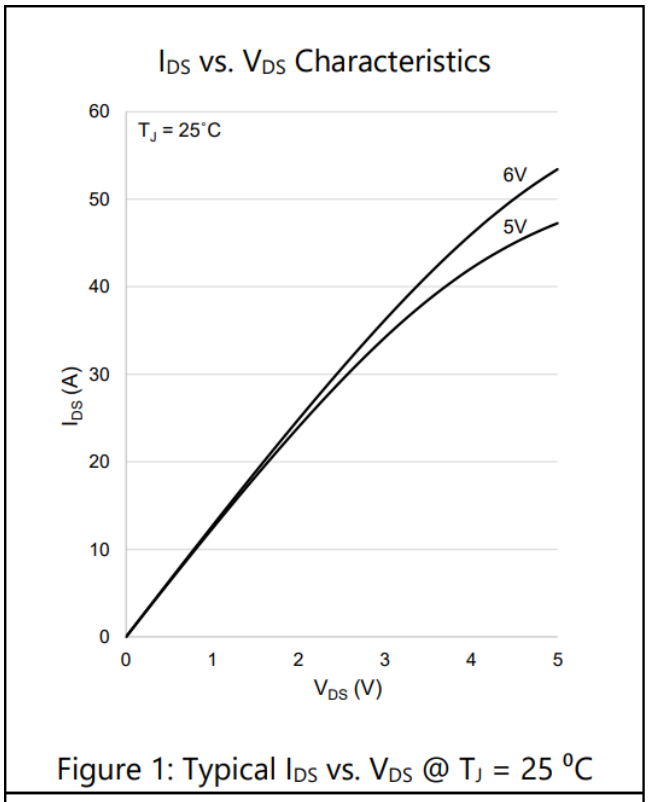


Figure 1: Typical I_{DS} vs. V_{DS} @ T_J = 25 °C

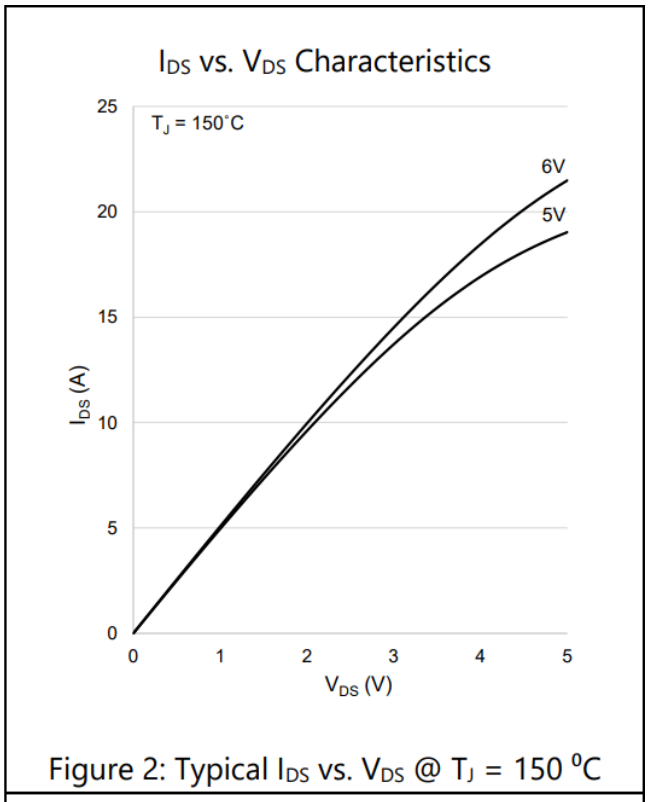


Figure 2: Typical I_{DS} vs. V_{DS} @ T_J = 150 °C

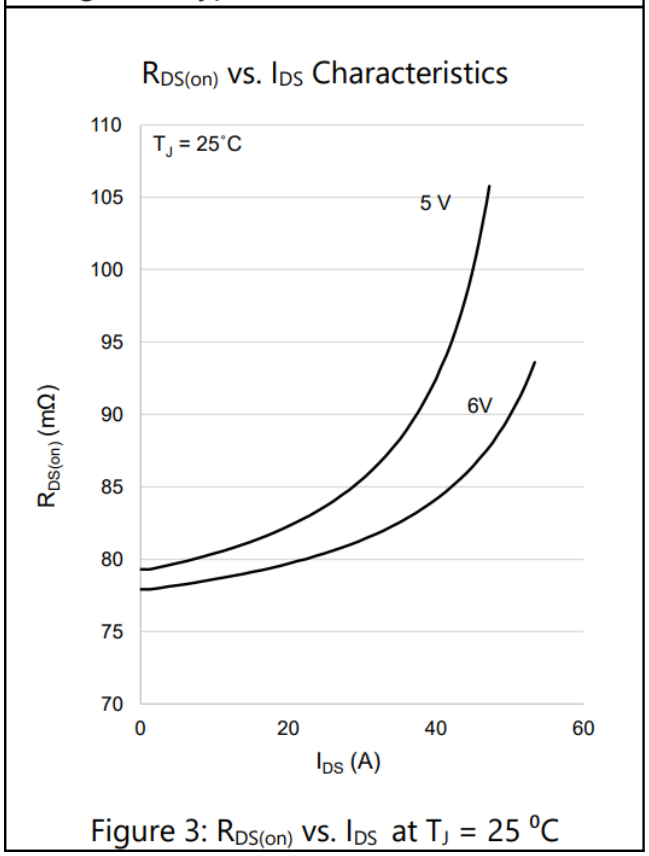


Figure 3: $R_{DS(on)}$ vs. I_{DS} at T_J = 25 °C

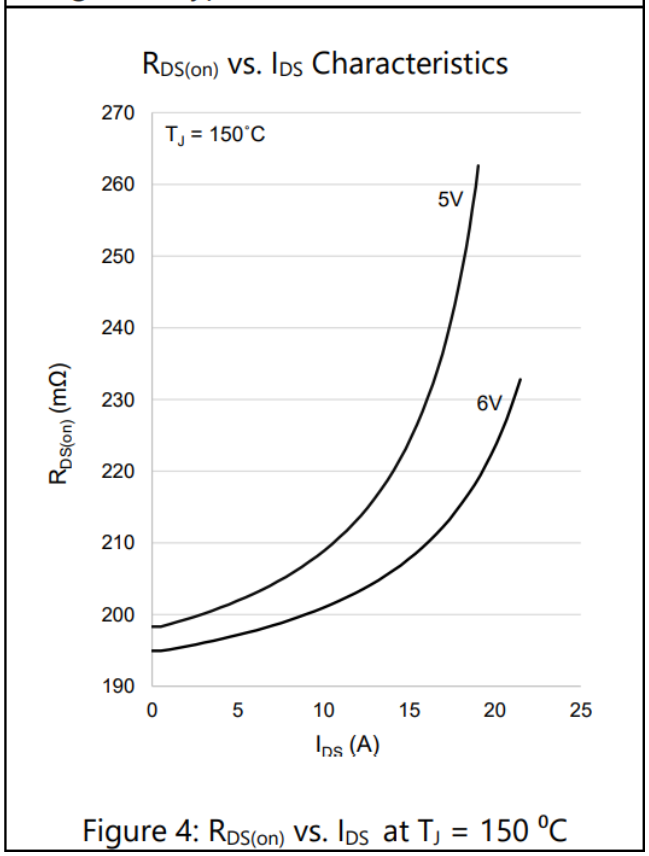


Figure 4: $R_{DS(on)}$ vs. I_{DS} at T_J = 150 °C

Electrical Performance Graphs

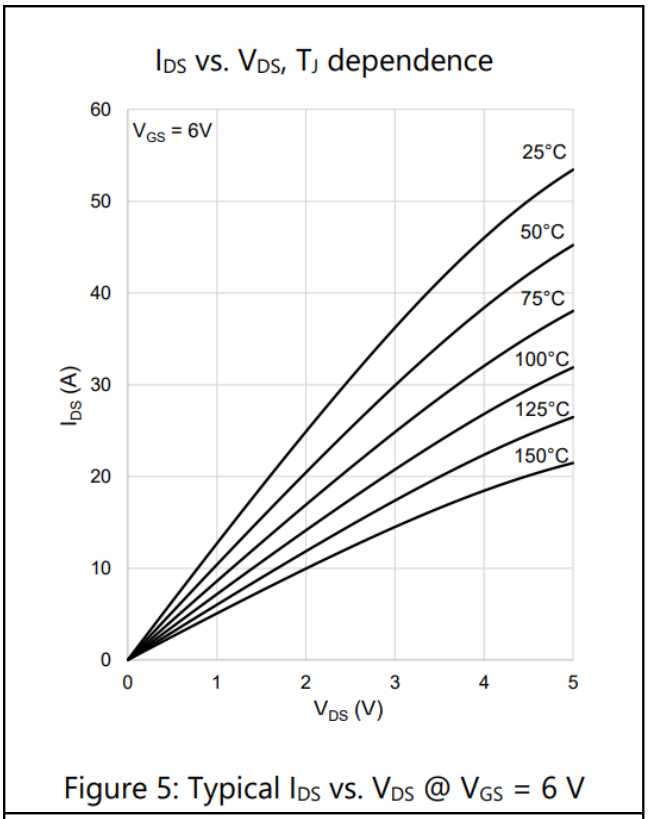


Figure 5: Typical I_{DS} vs. V_{DS} @ V_{GS} = 6 V

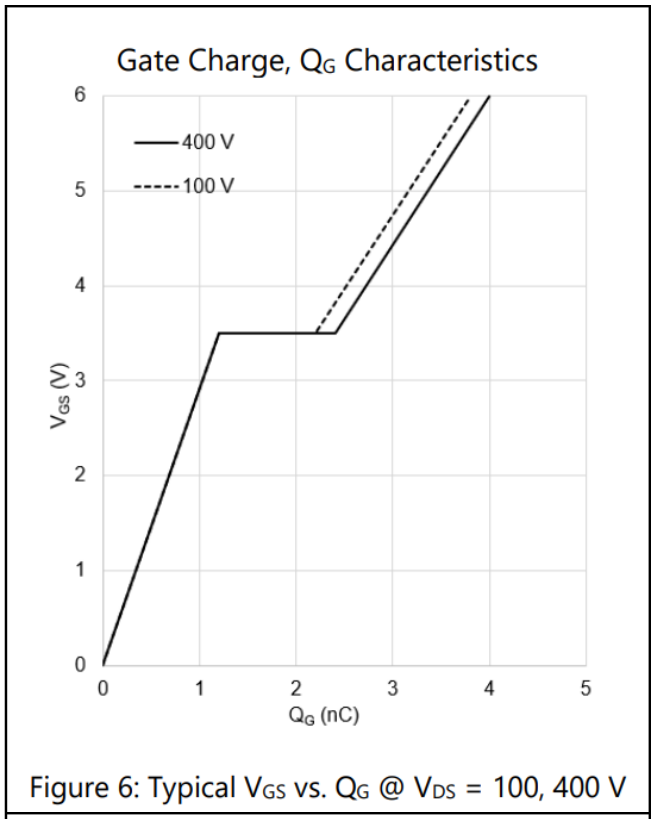


Figure 6: Typical V_{GS} vs. Q_G @ V_{DS} = 100, 400 V

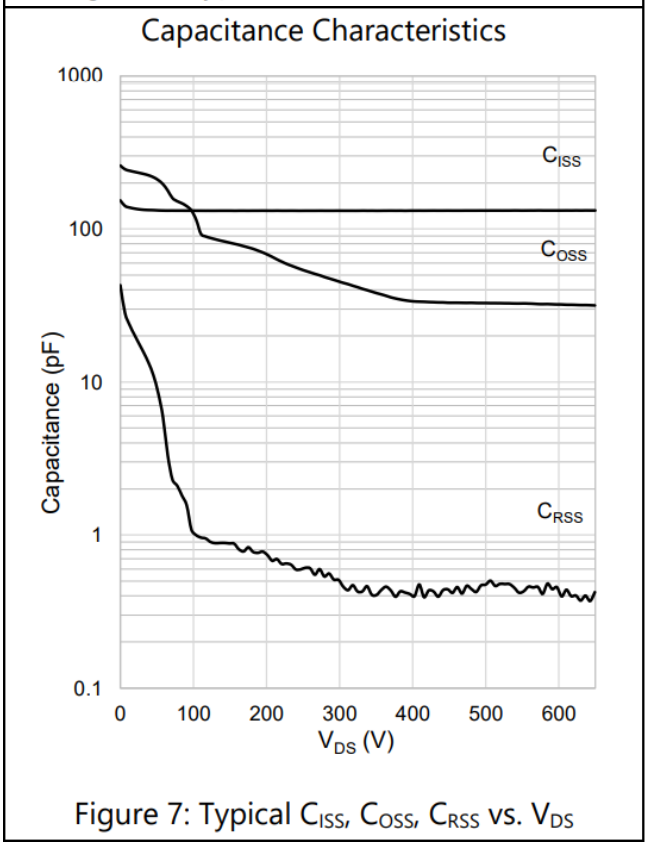


Figure 7: Typical C_{ISS}, C_{OSS}, C_{RSS} vs. V_{DS}

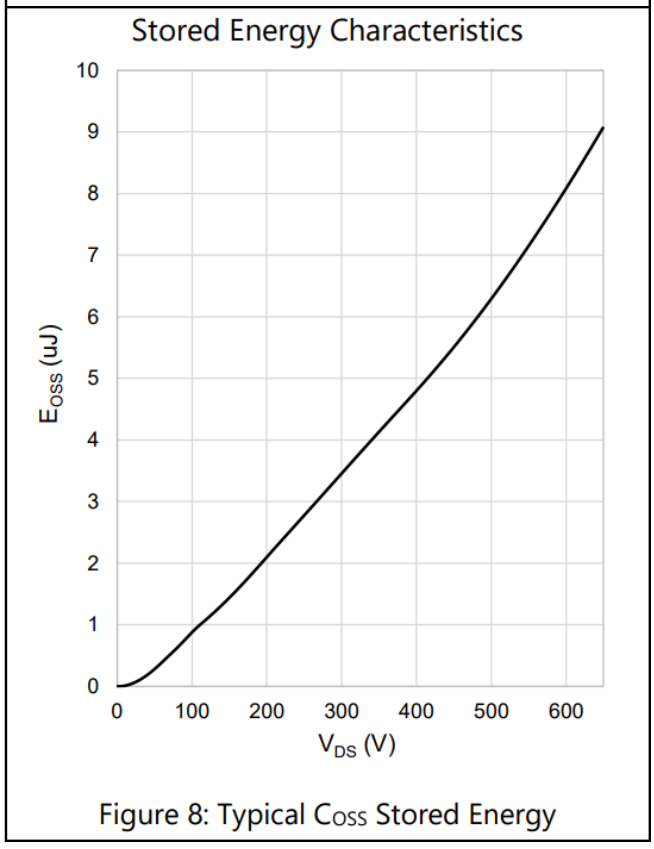


Figure 8: Typical C_{OSS} Stored Energy

Electrical Performance Graphs

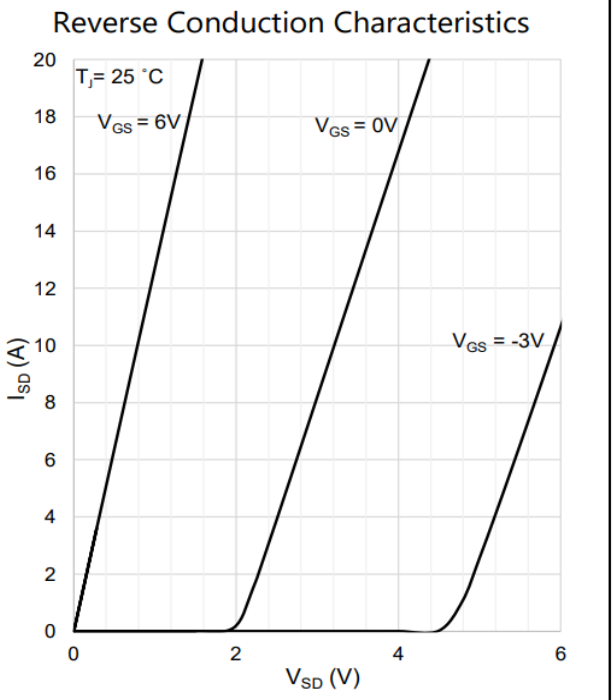


Figure 9: Typical I_{SD} vs. V_{SD} @ T_J = 25 °C

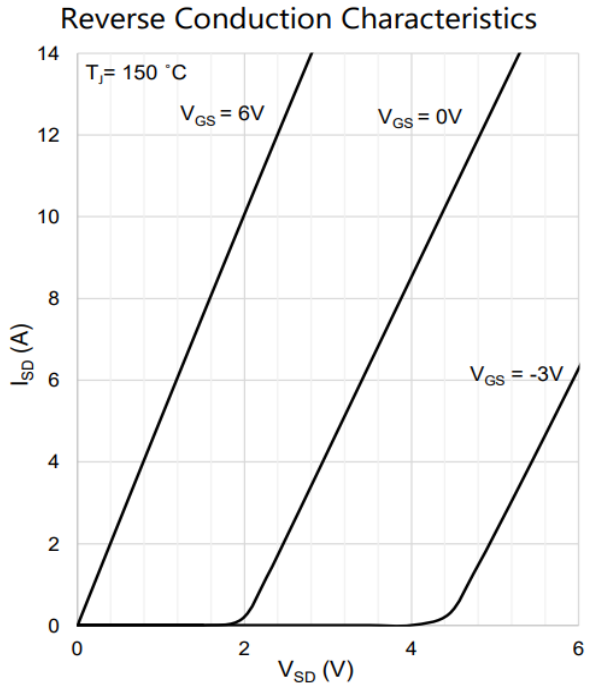


Figure 10: Typical I_{SD} vs. V_{SD} @ T_J = 150 °C

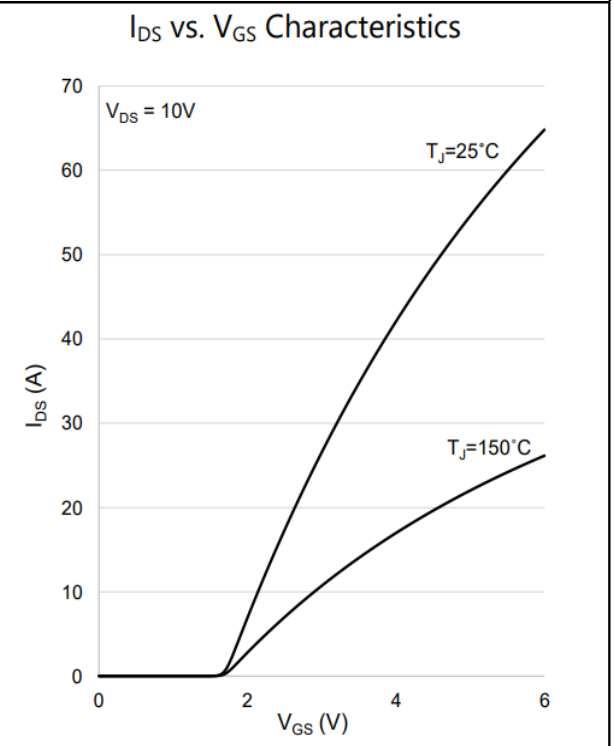


Figure 11: Typical I_{DS} vs. V_{GS}

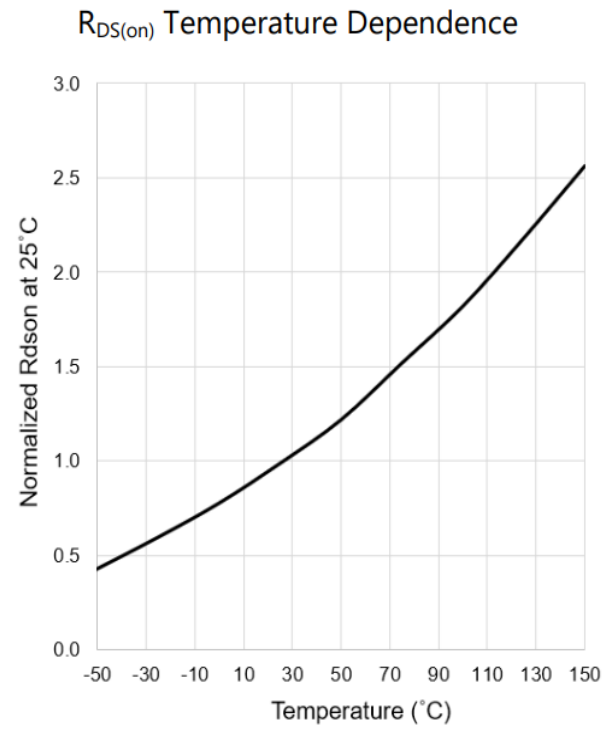


Figure 12: Normalized $R_{DS(on)}$ as function of T_J

Thermal Performance Graphs

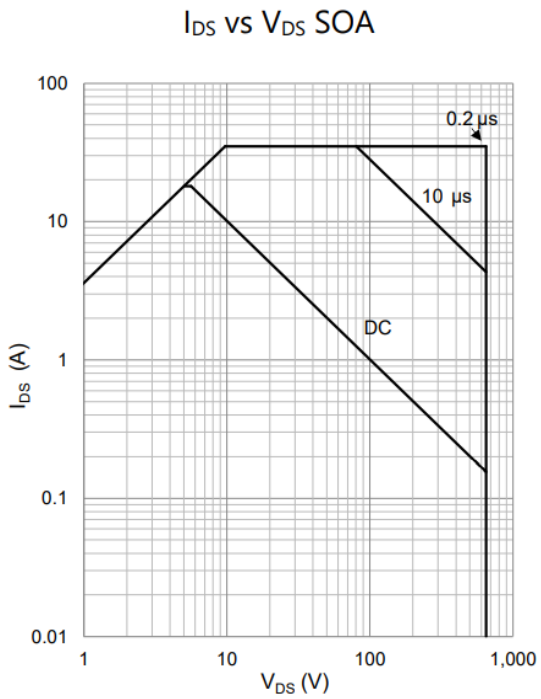


Figure 13: Safe Operating Area @ T_{case} = 25°C

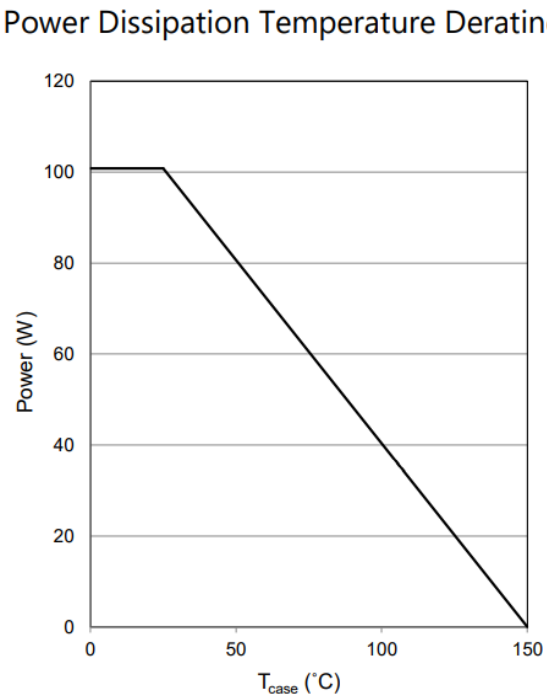


Figure 14: Derating vs. Case Temperature

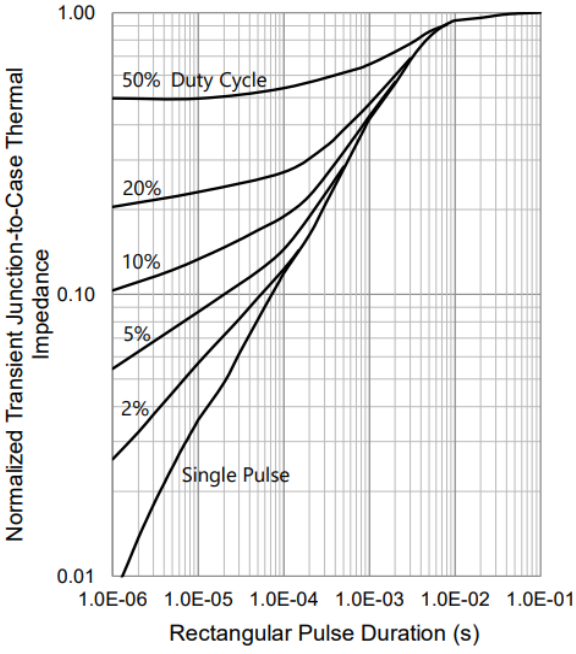


Figure 15: Transient Thermal Impedance
(1.00 = Nominal DC thermal impedance)

Test Circuits

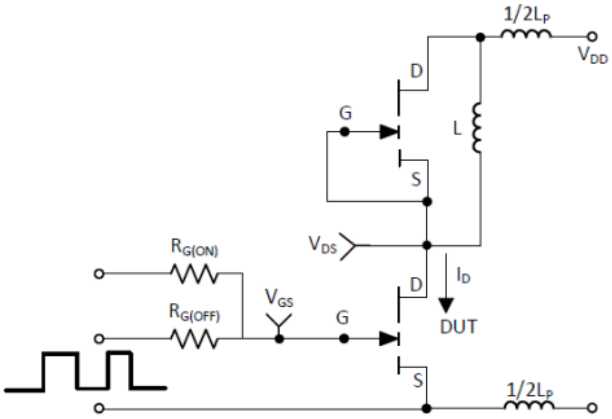
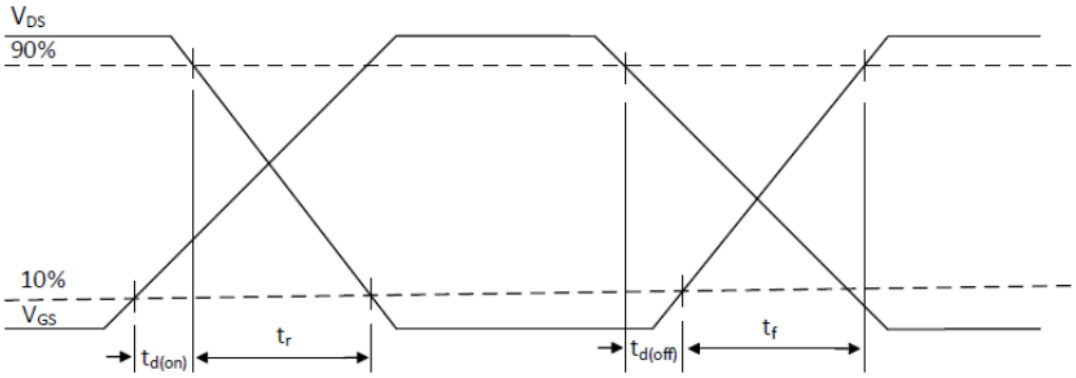
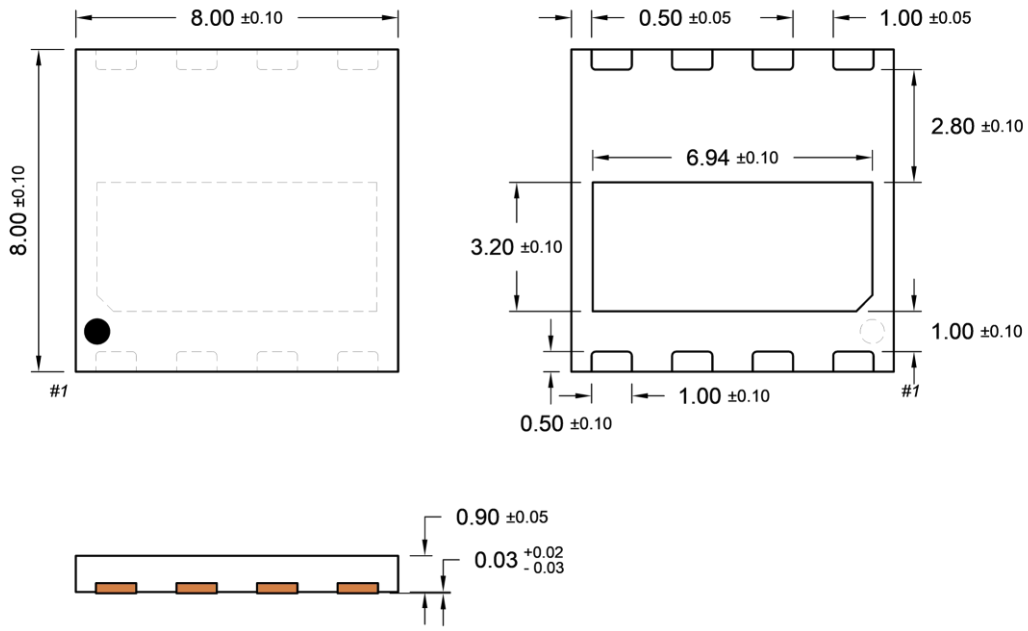


Figure 16: Switching Test Circuit

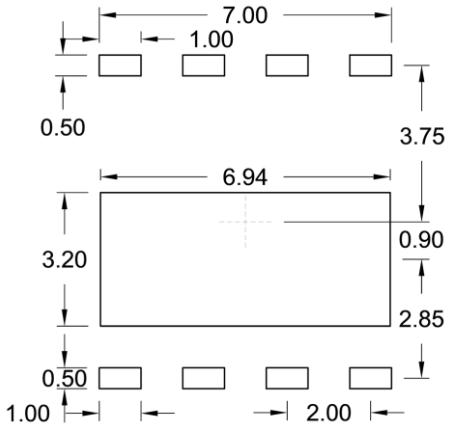


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

PDFN88



Recommended PCB Footprint



MARKING DIAGRAM



Y = Year Code
WW = Week Code (01~52)
L = Lot Code (1~9,A~Z)
F = Factory Code

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

ENTEGRECİ

Bu belge www.entegreci.com üzerinden sunulmaktadır.

Elektronik komponent tedarikinde Entegreci

Entegreci, Eskişehir merkezli, Türkiye geneline satış yapan bir elektronik komponent mağazasıdır. Entegreler (IC), mikrodenetleyiciler, transistörler, diyotlar, pasif elemanlar, konnektörler, modüller ve geliştirme kartları tek adetten seri üretim adetlerine kadar satılır. Ürün sayfalarında güncel stok durumunu, fiyatı ve datasheet bağlantısını bulabilirsiniz.

Parça koduyla arama

Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

www.entegreci.com

Ürün kategorileri

Entegreden kapasitöre tüm elektronik komponent kategorileri.

Kategorilere göz atın

Üreticiler

Aradığınız üreticinin ürünlerini tek sayfada inceleyin.

Üreticileri görün

Toplu alım ve teklif

Listede olmayan ya da yüksek adetli parçalar için teklif isteyin.

Teklif isteyin

www.entegreci.com | **destek@entegreci.com** | **0850 305 90 34**

Entegreci is an online electronic components store based in Türkiye. Search by manufacturer part number to see stock, prices and datasheets for integrated circuits, microcontrollers, transistors, passive components and connectors, or request a quote for parts that are not listed.

Bu sayfa Entegreci tarafından eklenmiştir. Belgenin önceki sayfaları asıl yayıncısına aittir ve içeriği değiştirilmemiştir; en güncel sürüm için belgenin yayıncısına başvurun.